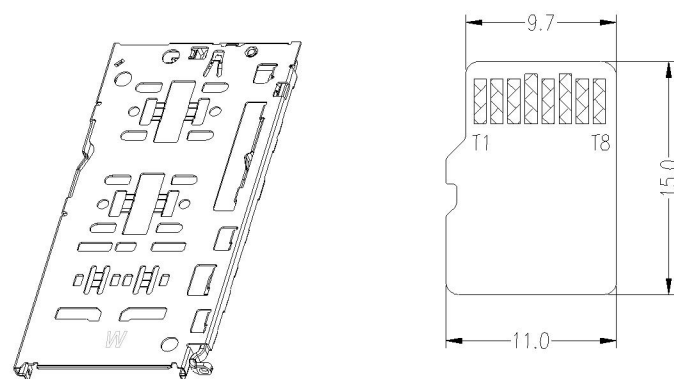


8P	描述	No.	描述
P1	Vcc	T1	DAT2
P2	RST	T2	CD/DAT3
P3	CLK	T3	CMD
--	Reserved	T4	VDD
P5	GND	T5	CLK
P6	Vpp	T6	Vss
P7	I/O	T7	DAT0
--	Reserved	T8	DAT1

DWG:		A-LXST14-13512-24		MATERIAL:		See note		深圳市连欣科技有限公司									
MODEL NO:				FINISH:		See note											
UNIT:		mm		SIZE:		A4						COLOR:		See note			
TOLERANCE UNSPECIFIED				DR:													
		.x		±0.10		CHK:		PART NO:				XDST-13512-29#		REV:		A	
		.xx		±0.05													
		.xxx		±0.03													
		ANG.		±1°		APP:		SCALE:		1:1		SHEET:		2/2			

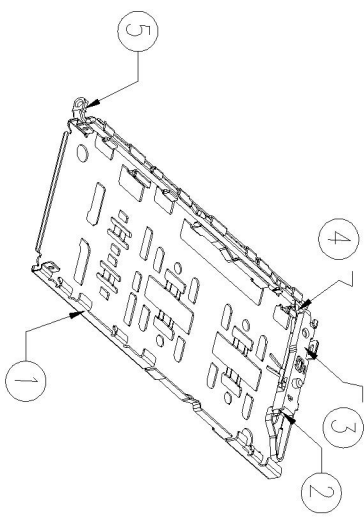
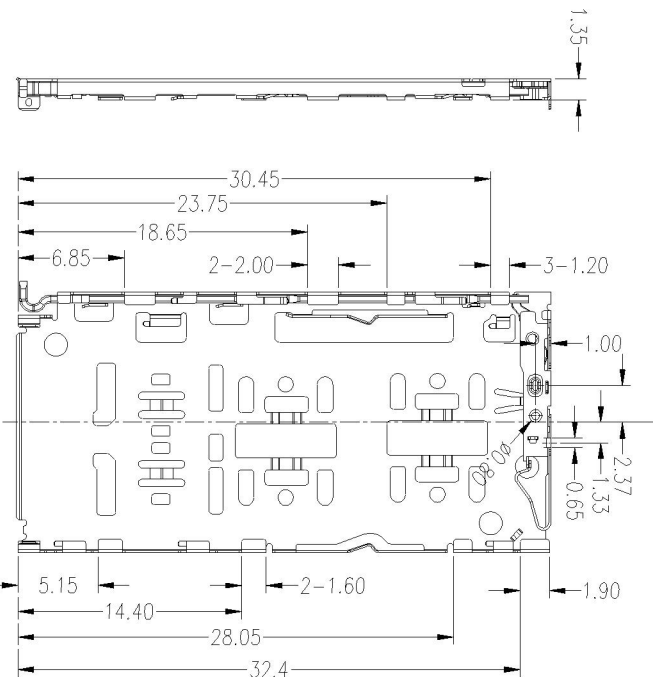
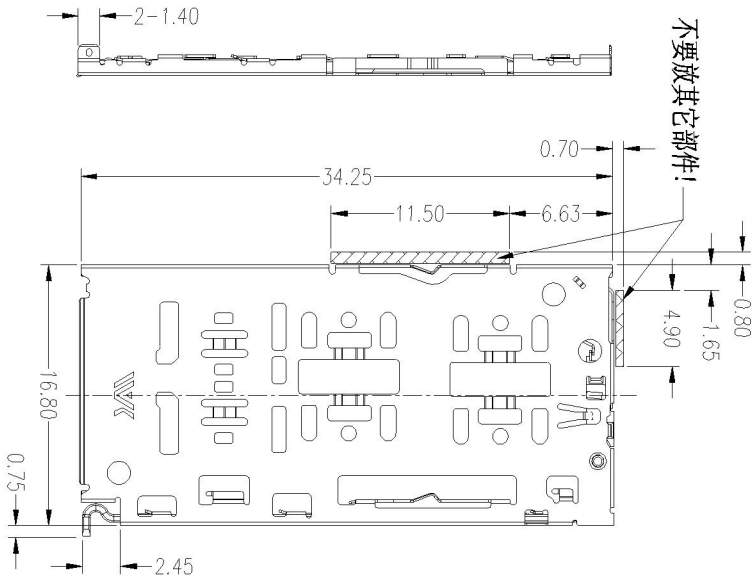
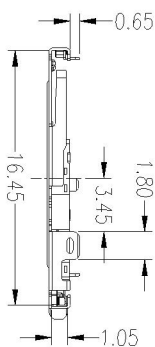
深圳市连欣科技有限公司

TITLE: 三选三(双Nano Sim卡+TF卡,组合件)1.35H

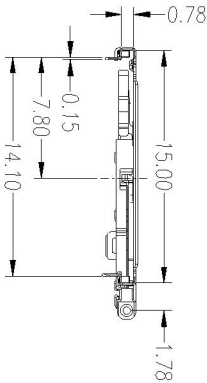
PART NO:	XDST-13512-29#
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SCALE:	1:1	SHEET:	2/2
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REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
A						



Note:
1. Specification:
1.1 Voltage Rating: 10V
1.2 Current rating: 1 A Max.
1.3 Dielectric withstanding voltage: 250 V(ac) for 1 min.
1.4 Contact resistance: 50 mΩ Max.
1.5 Insulation resistance: 1000 MΩ Min.
1.6 Durability: 3000 Cycles
1.7 Temperature range: -30°C~80°C



卷装	Ø330*24.0/W=56.0;P=24.0	1000	10000
包装方式	规格	卷数	总数

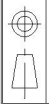
Before Tray Insert	Close
Shell	S/W Pin
After Tray Insert	Open
Shell	S/W Pin

5	Pusher	Sus301 T=0.45	N/A
4	CAM	Sus301 T=0.40	N/A
3	Detact Housing	LCP 6130;Black	UL 94V-0
2	Switch Pin	C5191 T=0.15	50u"Min. Ni underplated all;1~3u"Min;Au plated Contact Area;Solderails
1	Shell	Sus301 T=0.15	50u"Min. Ni Plated all;
No.	Name	Material	Finish
DWG: A-LAST14-B13512-29			
MODEL NO:		FINISH:	See note
UNIT: mm		SIZE: A4	See note
TOLERANCE UNSPECIFIED		DR:	See note
.X		CHK:	See note
.XX		APP:	See note
.XXX		SCALE:	1:1
ANG.		SHEET:	1/2
		REV:	A

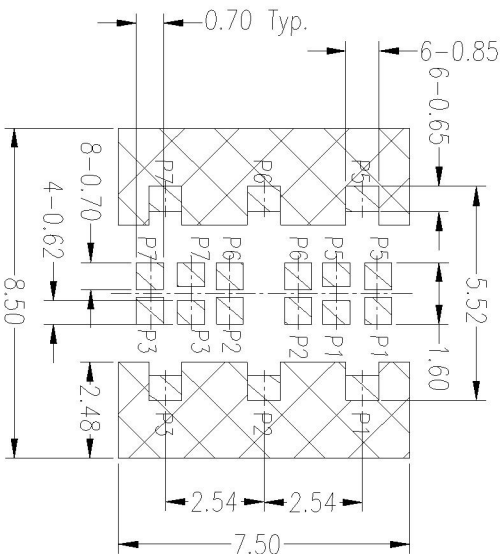
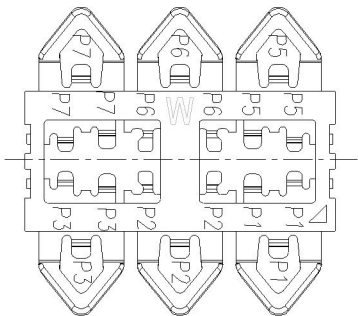
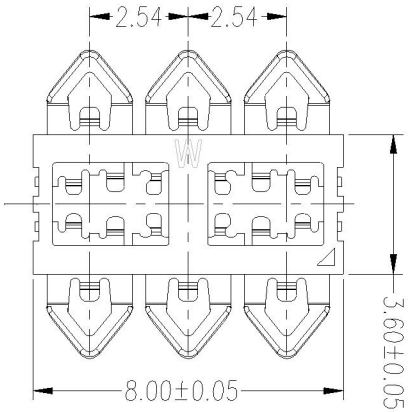
深圳市连欣科技有限公司

三选三(双Nano Sim卡+TF卡,组合件)1.35H

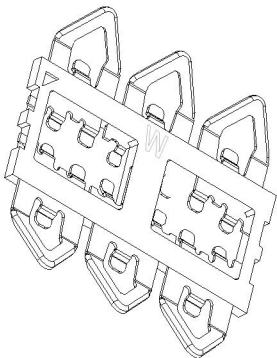
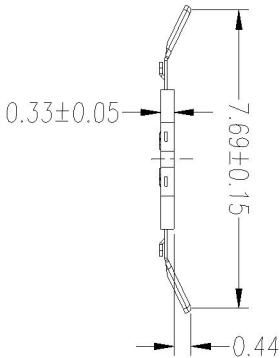
PART NO: XDST-13512-29#



REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPO
A						



Recommended PCB Layout



焊接区!

禁止布线 (至少表层不能露铜)!

Nanosim卡 Pin脚定义

8P	描述
P1	Vcc
P2	RST
P3	CLK
--	Reserved
P5	GND
P6	Vpp
P7	I/O
--	Reserved

卷装

Ø330*24.0/W=16.0;P=12.0

3500

35000

包装方式

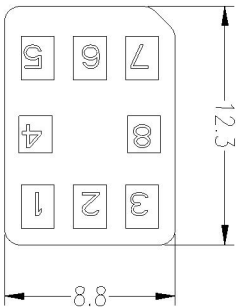
规格

卷数

总数

深圳市连欣科技有限公司

DWG:	A-1-LSM06-B254112-25	MATERIAL:	See note
MODEL NO:		FINSH:	See note
UNIT:	mm	SIZE:	A4
SIZE:	A4	COLOR:	See note
TOLERANCE UNSPECIFIED		DR:	
.x	±0.25	CHK:	
.xx	±0.10	APP:	
.xxx	±0.05	SCALE:	1:1
ANG.	±1°	SHEET:	2/2

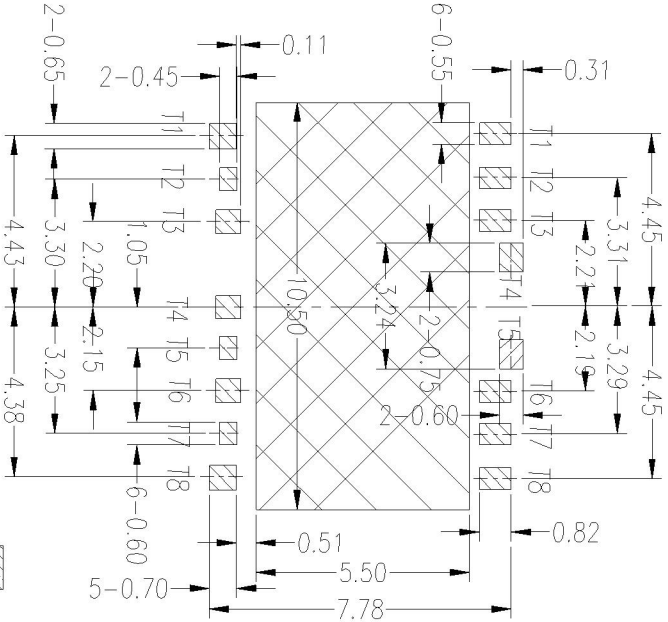
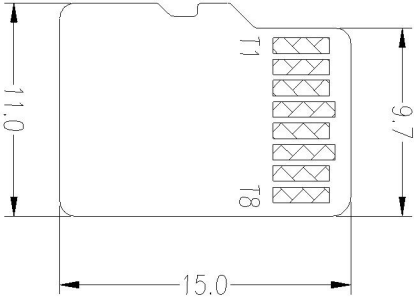
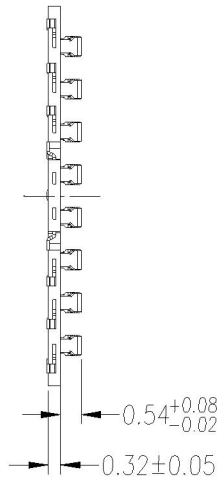
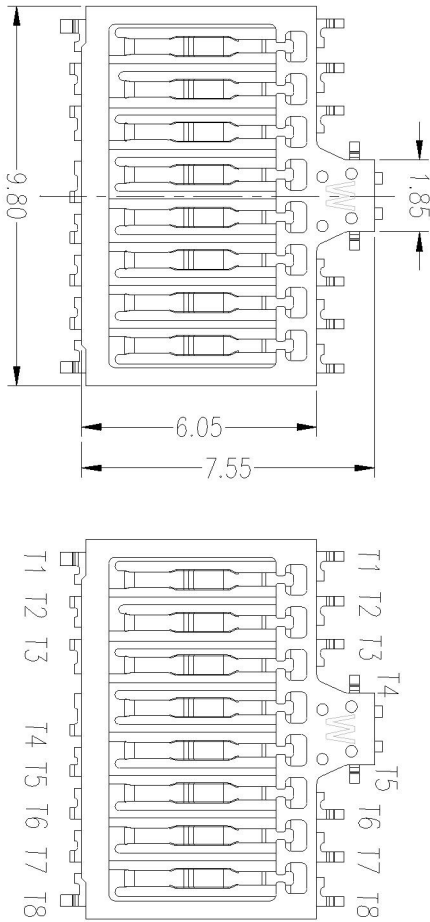
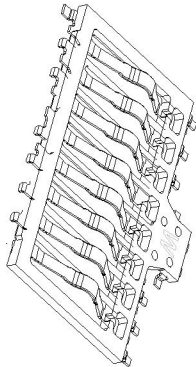


三选三(双Nano Sim卡+TF卡)1.35H Nanosim卡主体

XDST-13512-29#

REV: A

REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPO
A						



Recommended PCB Layout



焊接区!



禁止布线 (至少表层不能露铜)!

TF卡 Pin脚定义

No.	描述
T1	DAT2
T2	CD/DAT3
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1

卷装

Ø330*24.0/W=16.0;P=12.0

3000

42000

规格

卷数

总数

深圳市连欣科技有限公司

DWG: A-1XTF08-B11012-17		MATERIAL: See note	
MODEL NO:		FINSH: See note	
UNIT: mm		SIZE: A4	
TOLERANCE UNSPECIFIED		COLOR: See note	
.x ±0.25		DR:	
.xx ±0.10		CHK:	
.xxx ±0.05		APP:	
ANG. ±1°		TITLE:	
PART NO: XDST-13512-29#		三选三(双Vano Sim卡+TF卡)1.35H-TF主体	
SCALE: 1:1		SHEET: 2/2	
		REV: A	

